V20DL45BP

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Vishay General Semiconductor

# TMBS<sup>®</sup> (Trench MOS Barrier Schottky) Rectifier for PV Solar Cell Bypass Protection

Ultra Low  $V_F = 0.31$  V at  $I_F = 5$  A





## **DESIGN SUPPORT TOOLS AVAILABLE**



PRIMARY CHARACTERISTICS				
I <sub>F(AV)</sub>	20 A			
V <sub>RRM</sub>	45 V			
I <sub>FSM</sub>	160 A			
V <sub>F</sub> at I <sub>F</sub> = 20 A (T <sub>A</sub> = 125 °C)	0.50 V			
T <sub>OP</sub> max. (AC model)	150 °C			
$T_J$ max. (DC forward current)	200 °C			
Package	SMPD (TO-263AC)			
Circuit configuration	Single			

### FEATURES

- Trench MOS Schottky technology
- Very low profile typical height of 1.7 mm
- Ideal for automated placement
- · Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

## TYPICAL APPLICATIONS

For use in solar cell junction box as a bypass diode for protection, using DC forward current without reverse bias.

## **MECHANICAL DATA**

**Case:** SMPD (TO-263AC) Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 1A whisker test

Polarity: as marked

<b>MAXIMUM RATINGS</b> ( $T_A = 25 \text{ °C}$ unless otherwise noted)					
PARAMETER	SYMBOL	V20DL45BP	UNIT		
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	45	V		
Maximum DC forward current (fig. 1)	I <sub>F(DC)</sub> <sup>(1)</sup>	20	А		
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	160	А		
Operating junction temperature range (AC model)	T <sub>OP</sub>	-40 to +150	°C		
Junction temperature in DC forward current without reverse bias, $t$ = $\leq$ 1 h $$	T <sub>J</sub> <sup>(2)</sup>	≤ 200	°C		

### Note

(1) With heatsink

<sup>(2)</sup> Meets the requirements of IEC 61215 ed.2 bypass diode thermal test

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ROHS COMPLIANT

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<b>ELECTRICAL CHARACTERISTICS</b> ( $T_A = 25$ °C unless otherwise noted)						
PARAMETER	TEST CO	TEST CONDITIONS		TYP.	MAX.	UNIT
Instantaneous forward voltage	I <sub>F</sub> = 5 A	T <sub>A</sub> = 25 °C	- V <sub>F</sub> (1)	0.42	-	V
	I <sub>F</sub> = 10 A			0.48	-	
	I <sub>F</sub> = 20 A			0.55	0.64	
	I <sub>F</sub> = 5 A	T <sub>A</sub> = 125 °C		0.31	-	
	I <sub>F</sub> = 10 A			0.38	-	
	I <sub>F</sub> = 20 A			0.50	0.58	
Reverse current	V <sub>B</sub> = 45 V	T <sub>A</sub> = 25 °C	– I <sub>R</sub> <sup>(2)</sup>	-	2.5	mA
	V <sub>R</sub> = 45 V	T <sub>A</sub> = 125 °C	'R (-)	20	50	ШA

#### Notes

 $^{(1)}\,$  Pulse test: 300  $\mu s$  pulse width, 1 % duty cycle

<sup>(2)</sup> Pulse test: Pulse width  $\leq$  5 ms

<b>THERMAL CHARACTERISTICS</b> ( $T_A = 25 \text{ °C}$ unless otherwise noted)				
PARAMETER SYMBOL		V20DL45BP	UNIT	
Typical thermal resistance	$R_{\theta JC}$	1.6	°C/W	
	R <sub>0JA</sub> (1)(2)	45	C/ W	

### Notes

<sup>(1)</sup> The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ 

<sup>(2)</sup> Free air, without heatsink

ORDERING INFORMATION (Example)					
PACKAGE	PREFERRED P/N	UNIT WEIGHT (g)	PACKAGE CODE BASE QUANTITY		DELIVERY MODE
SMPD (TO-263AC)	V20DL45BP-M3/I	0.55	I	2000/reel	13" diameter plastic tape and reel

## **RATINGS AND CHARACTERISTICS CURVES** (T<sub>A</sub> = 25 °C unless otherwise noted)

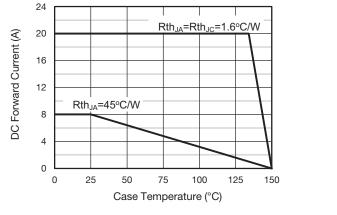


Fig. 1 - Forward Current Derating Curve

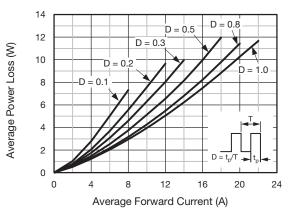


Fig. 2 - Forward Power Loss Characteristics

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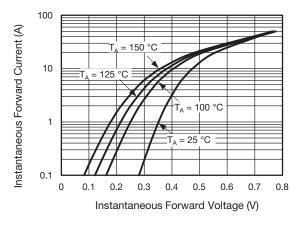


Fig. 3 - Typical Instantaneous Forward Characteristics

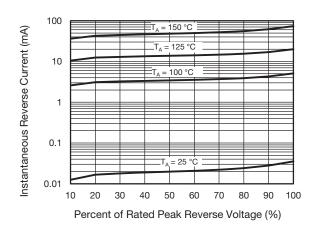


Fig. 4 - Typical Reverse Characteristics

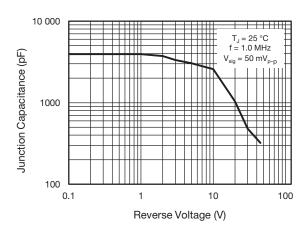


Fig. 5 - Typical Junction Capacitance

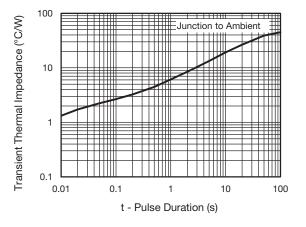


Fig. 6 - Typical Transient Thermal Impedance

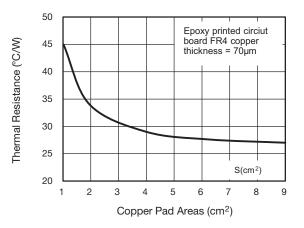


Fig. 7 - Thermal Resistance Junction-to-Ambient vs. Copper Pad Areas

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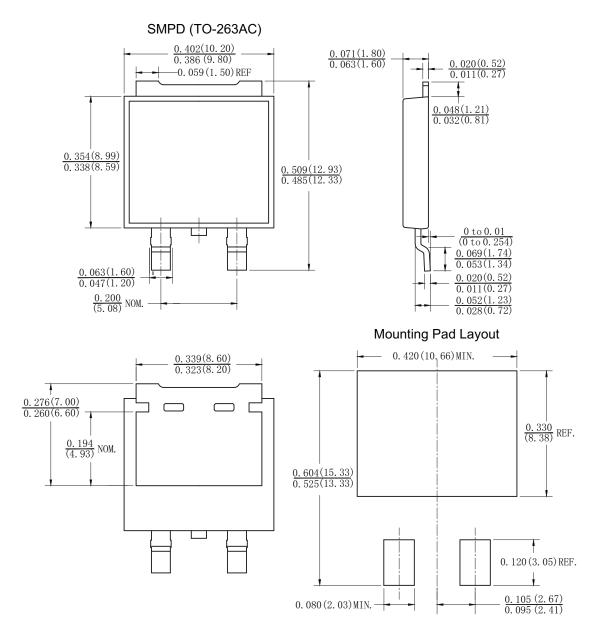
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## **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)





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